IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

pplicant

: Ming-Der Lin, et al.

Serial No.

: 10/657,170

: Art Unit #2811

Filed

: 9 September 2003

: Examiner: Unknown

Title

: ORGANIC ELECTROLUMINESCENT

DEVICE AND METHOD FOR PRODUCING

THE SAME

TRANSMITTAL LETTER ACCOMPANYING SUBSTITUTE DECLARATION

Mail Stop NO FEE Honorable Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Applicant, by the undersigned attorney hereby submits a Substitute Declaration for Patent Application properly claiming priority of Taiwan Patent Application Serial No. 91120668 having a filing date in Taiwan, R.O.C. of 11 September 2002.

The Priority Document which is a certified copy of the Taiwan Patent Application as filed, was filed with the above-referenced patent application.

It is now believed that all matters associated with the claiming of priority have been completed. Entry of the Substitute Declaration for Patent Application is hereby requested.

Respectfully submitted,

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Morton J. Rosenberg

Registration No. 26,049

Dated: 15 Lee. 2003

PATENT TRADEMARK OFFICE

Page 1 of 1

SUBSTITUTE:DECLA	RATION FOR PATENT	APPLICATION Cocket Number (Optional) MR3003-60		
As a below named inventor, I hereby decla	re that:	DEC 1 6 2003 E		
My residence, post office address and citizenship are as stated below next to my name.				
names are listed below) of the subject mat	ter which is claimed and for whice and method for producing box is checked: as United States Appli	below) or an original stand joint inventor (if plural ch a patent is sought on the invention entitled cing the same the specification of cation Number or PCT International Application (if applicable).		
I hereby state that I have reviewed and und	derstand the contents of the abo	ve identified specification, including the claims, as		
inventor's certificate, or §365(a) of any PC United States, listed below and have also i	tion which is material to patenta er 35 U.S.C. §119(a)-(d) or §365 T International application which dentified below, by checking the	bility as defined in 37 CFR §1.56. 5(b) of any foreign application(s) for patent or a designated at least one country other than the box, any foreign application for patent or inventor's of the application on which priority is claimed. Priority Not Claimed 11/9/2002		
(Number)	(Country)	(Day/Month/Year Filed)		
(Number) I hereby claim the benefit under 35 U.S.C.	(Country) §119(e) of any United States pr	(Day/Month/Year Filed) ovisional application(s) listed below.		
(Application Number)	(Filing Date)	·		
application designating the United States, is not disclosed in the prior United States of 35 U.S.C. §112. I acknowledge the duty to disclose information	listed below and, insofar as the or PCT International application ation which is material to patenta	ication(s), or §365(c) of any PCT International subject matter of each of the claims of this application in the manner provided by the first paragraph of ability as defined in 37 CFR §1.56 which became r PCT International filing date of this application.		
(Application Number)	(Filing Date)	(Status-patented, pending, abandoned)		
(Application Number) (Filing Date) (Status-patented, pending, abandoned) I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office Connected therewith: MORTON J. ROSENBERG, ESQ., REG. # 26,049; DAVID I. KLEIN, ESQ.,REG. # 33,253; JUN Y. LEE, ESQ., REG. # 40,262 Address all telephone calls to Address all correspondence to ROSENBERG at telephone number 410-465-6678 ROSENBERG, KLEIN & LEE 3458 ELLICOTT CENTER DRIVE-SUITE 101 ELLICOTT CITY, MD 21043 FAX #: 410-461-3067 E-MAIL ADDRESS: rkl@rklpatlaw.com				
and belief are believed to be true; and furt	herein of my own knowledge archer that these statements were ne or imprisonment, or both, und jeopardize the validity of the apame, family name) Ming-Der Ming-Der Rd., Hsinchu, Taiwan 300, R.O. given name, family name) Fe	e true and that all statements made on information made with the knowledge that willful false statements for Section 1001 of Title 18 of the United States Code plication or any patent issued thereon. LIN Date 9/17/2003 C. ng-Ju CHUANG		
	e 78, Chu-Kuang Rd., Hsinchu, T	aiwan, 300, R.O.C.		
☑ Additional Inventors are being na	amed on separately numbered s	heets attached hereto.		

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